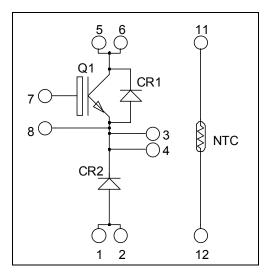
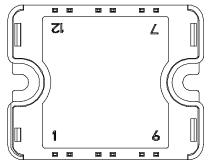


Buck chopper High speed Trenchstop 5 IGBT Power Module

$$V_{CES} = 650V$$

 $I_{C} = 100A$ @ $Tc = 25^{\circ}C$





Pins 1/2; 3/4; 5/6 must be shorted together

Application

- AC and DC motor control
- Switched Mode Power Supplies

Features

- Trench + Field Stop IGBT5 technology
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 100 kHz
 - Low leakage current
- Very low stray inductance
- Internal thermistor for temperature monitoring

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- · RoHS compliant

All ratings @ $T_i = 25$ °C unless otherwise specified

Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
V_{CES}	Collector - Emitter Voltage		650	V
Ţ	Continuous Collector Current	$T_C = 25^{\circ}C$	100	
I_{C}	Continuous Collector Current $T_C = 80^{\circ}C$		60	Α
I_{CM}	Pulsed Collector Current	$T_C = 25^{\circ}C$	200	
V_{GE}	Gate – Emitter Voltage		±20	V
P_{D}	Power Dissipation	_	250	W

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

1 - 6



Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I_{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0V, V_{CE} = 650V$				100	μΑ
V _{CE(sat)}	Collector Emitter Saturation Voltage	$V_{GE} = 15V$	$T_j = 25^{\circ}C$		1.65	2.2	V
		$I_{\rm C} = 100 {\rm A}$ $T_{\rm j} = 150 {\rm ^{\circ}C}$		1.9		V	
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 1mA$		3.3	4.0	4.7	V
I_{GES}	Gate – Emitter Leakage Current	$V_{GE} = 20V, V_{CE} = 0V$				240	nA

Dynamic Characteristics

Symbol	Characteristic	Test Condition	ns	Min	Тур	Max	Unit
Cies	Input Capacitance	$V_{GE} = 0V$	$V_{GE} = 0V$ $V_{CE} = 25V$ $f = 1MHz$		6000		
C_{oes}	Output Capacitance				100		pF
C_{res}	Reverse Transfer Capacitance	f = 1MHz			22		
Q_{G}	Gate charge	$V_{GE} = 15V, I_{C}$ $V_{CE} = 520V$	$V_{GE} = 15V, I_C = 100A$ $V_{CE} = 520V$		240		nC
$T_{d(on)}$	Turn-on Delay Time		Inductive Switching (25°C)		21		
T_{r}	Rise Time	$V_{GE} = 15V$			15		
$T_{d(off)}$	Turn-off Delay Time		$V_{Bus} = 400V$ $I_{C} = 50A$ $R_{G} = 2\Omega$		180		ns
T_{f}	Fall Time				18		
$T_{d(on)}$	Turn-on Delay Time		Inductive Switching (150°C) $V_{GE} = 15V$ $V_{Bus} = 400V$ $I_{C} = 50A$ $R_{G} = 2\Omega$		20		ns
T_{r}	Rise Time				15		
$T_{d(off)}$	Turn-off Delay Time				205		
T_{f}	Fall Time				26		
Eon	Turn on Energy	$V_{GE} = 15V$ $V_{Bus} = 400V$	$T_j = 150$ °C		1.5		mJ
E_{off}	Turn off Energy	$I_{C} = 50A$ $R_{G} = 2\Omega$	$T_j = 150$ °C		0.6		1113
R_{Gint}	Integrated gate resistor				2.5		Ω
R_{thJC}	Junction to Case Thermal Resistance					0.6	°C/W

Diode ratings and characteristics (Per diode)

Symbol	Characteristic	Characteristic Test Conditions		Min	Typ	Max	Unit
V_{RRM}	Peak Repetitive Reverse Voltage					650	V
I_{RM}	Reverse Leakage Current	$V_{R} = 650V$				100	μΑ
I_F	DC Forward Current		$Tc = 25^{\circ}C$		100		A
$V_{\rm F}$	Diode Forward Voltage	$I_F = 100A$ $V_{GE} = 0V$	$T_i = 25^{\circ}C$		1.6	2.2	V
v _F		$V_{GE} = 0V$	$T_{i} = 150^{\circ}C$		1.65		V
t_{rr}	Reverse Recovery Time	ary Time	$T_j = 25^{\circ}C$		46		ns
·rr	1F -	$I_F = 50A$ $V_R = 400V$	$T_{\rm j} = 50$ A $T_{\rm j} = 150$ °C		62		113
	**	$di/dt = 3000A/\mu s$	$T_j = 25^{\circ}C$		1		
Vп			$T_j = 150$ °C		2		μC
R_{thJC}	Junction to Case Thermal Resistance					0.7	°C/W

2 - 6



$\label{thm:complex} \textbf{Temperature sensor NTC} \ \ (\text{see application note APT0406 on www.microsemi.com}).$

Symbol	Characteristic			Тур	Max	Unit
R ₂₅	Resistance @ 25°C			50		kΩ
$\Delta R_{25}/R_{25}$				5		%
$B_{25/85}$	$T_{25} = 298.15 \text{ K}$			3952		K
$\Delta \mathrm{B/B}$		T _C =100°C		4		%

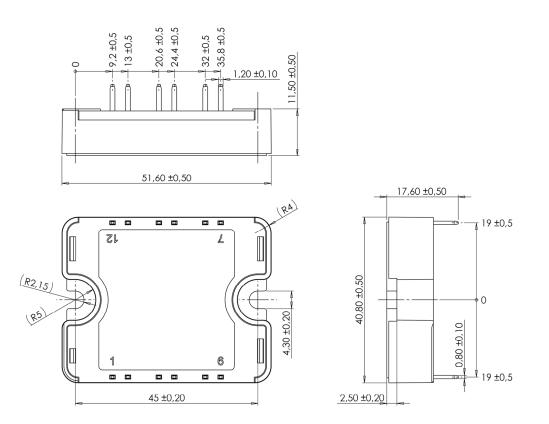
$$R_T = \frac{R_{25}}{\exp \left[B_{25/85} \left(\frac{1}{T_{25}} - \frac{1}{T} \right) \right]} \quad \text{T: Thermistor temperature}$$

$$R_T: \text{ Thermistor value at T}$$

Thermal and package characteristics

Symbol	Characteristic			Min	Max	Unit
V_{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz					V
T_{J}	Operating junction temperature range				175	
T_{JOP}	Recommended junction temperature under switching conditions			-40	T _J max -25	°C
T_{STG}	Storage Temperature Range			-40	125	
$T_{\rm C}$	Operating Case Temperature			-40	125	
Torque	Mounting torque	To heatsink	M4	2	3	N.m
Wt	Package Weight	•			80	g

Package outline (dimensions in mm)

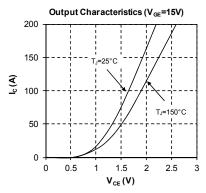


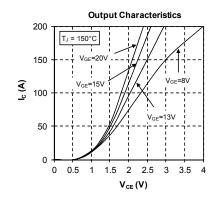
See application note 1904 - Mounting Instructions for SP1 Power Modules on www.microsemi.com

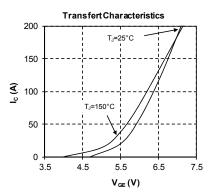
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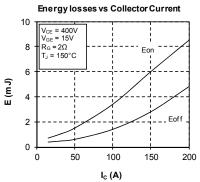


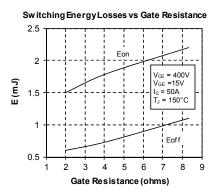
Typical performance curve

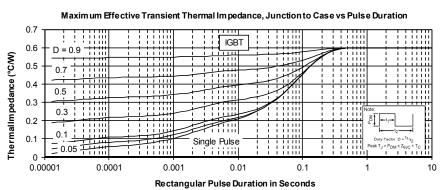






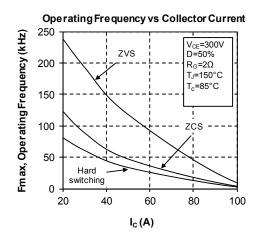


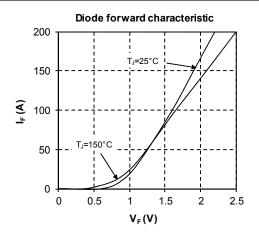


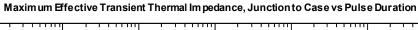


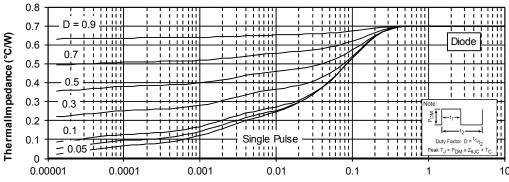


Power Matters.™









Rectangular Pulse Duration in Seconds



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